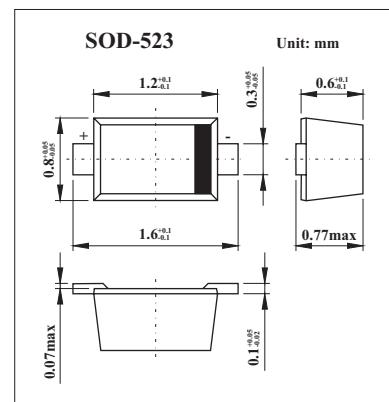


# **1PS79SB30**

## ■ Features

- Very Low forward voltage
- Very Low reverse current
- Guard ring protected
- Ultra small plastic SMD package.



## ■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Conditions	Min	Max	Unit
continuous reverse voltage	V <sub>R</sub>			40	V
continuous forward current	I <sub>F</sub>			200	mA
repetitive peak forward current	I <sub>FSM</sub>	t <sub>p</sub> ≤ 1 s; δ ≤ 0.5		300	mA
non-repetitive peak forward current	I <sub>FSM</sub>	t = 8.3 ms half sinewave; JEDEC method		1	A
storage temperature	T <sub>stg</sub>		-65	+150	°C
junction temperature	T <sub>j</sub>			150	°C
operating ambient temperature	T <sub>amb</sub>		-65	+150	°C

## ■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Conditions	Typ	Max	Unit
forward voltage	V <sub>F</sub>	I <sub>F</sub> = 0.1 mA	190	220	mV
		I <sub>F</sub> = 1 mA	250	290	
		I <sub>F</sub> = 10 mA	320	360	
		I <sub>F</sub> = 100 mA	440	500	
		I <sub>F</sub> = 200 mA	520	600	
capacitance reverse current	I <sub>R</sub>	V <sub>R</sub> = 25 V, note 1;		0.5	μ A
diode capacitance	C <sub>d</sub>	V <sub>R</sub> = 1 V, f = 1 MHz;		20	pF
thermal resistance from junction to ambient	R <sub>th j-a</sub>			450	K/W

Note

1. Pulse test: pulse width = 300 μ s, δ = 0.02.

## ■ Marking

Marking	G1
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